

FEATURES

- Double Side Cooling
- High Surge Capability

APPLICATIONS

- High Power Drives
- High Voltage Power Supplies
- Static Switches

VOLTAGE RATINGS

Part and Ordering Number	Repetitive Peak Voltages V_{DRM} and V_{RRM} V	Conditions
DCR1650C65*	6500	$T_{vj} = -40^{\circ}\text{C}$ to 125°C , $I_{DRM} = I_{RRM} = 300\text{mA}$, $V_{DRM}, V_{RRM} t_p = 10\text{ms}$, $V_{DSM} \& V_{RSM} =$ $V_{DRM} \& V_{RRM} + 100\text{V}$ respectively
DCR1650C60	6000	
DCR1650C55	5500	
DCR1650C50	5000	

Lower voltage grades available.
 * 6200V @ -40°C , 6500V @ 0°C

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DCR1650C65

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

KEY PARAMETERS

V_{DRM}	6500V
$I_{T(AV)}$	1650A
I_{TSM}	22000A
dV/dt^*	1500V/μs
di/dt	300A/μs

* Higher dV/dt selections available

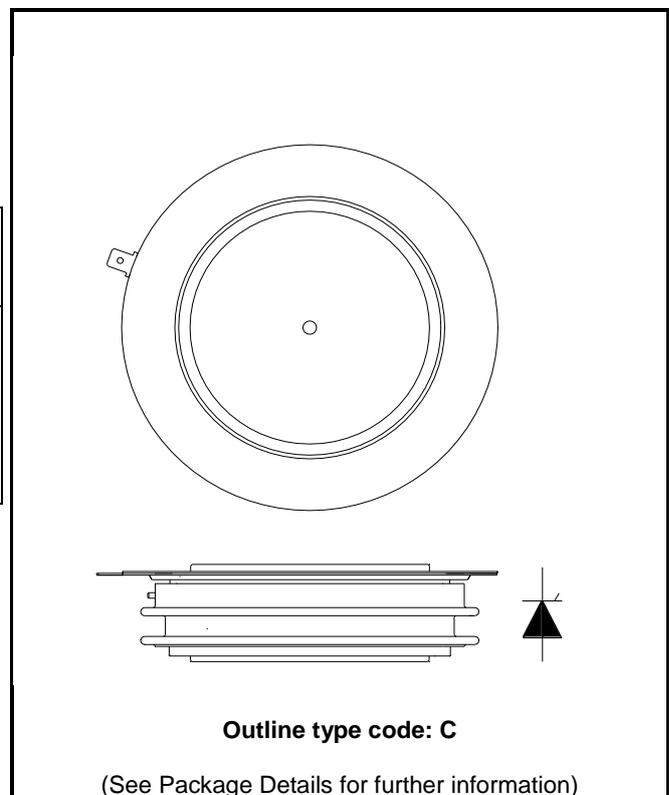


Fig. 1 Package outline

CURRENT RATINGS

$T_{case} = 60^{\circ}\text{C}$ unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Double Side Cooled				
$I_{T(AV)}$	Mean on-state current	Half wave resistive load	1650	A
$I_{T(RMS)}$	RMS value	-	2590	A
I_T	Continuous (direct) on-state current	-	2575	A

SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
I_{TSM}	Surge (non-repetitive) on-state current	10ms half sine, $T_{case} = 125^{\circ}\text{C}$	22.0	kA
I^2t	I^2t for fusing	$V_R = 0$	2.42	MA^2s

THERMAL AND MECHANICAL RATINGS

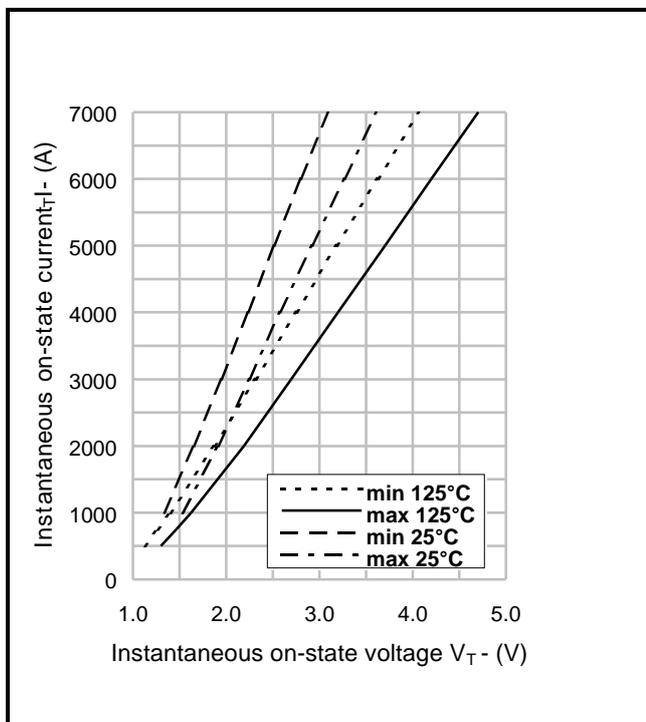
Symbol	Parameter	Test Conditions	Min.	Max.	Units	
$R_{th(j-c)}$	Thermal resistance – junction to case	Double side cooled	DC	-	0.0101	$^{\circ}\text{C/W}$
		Single side cooled	Anode DC	-	0.0176	$^{\circ}\text{C/W}$
			Cathode DC	-	0.0239	$^{\circ}\text{C/W}$
$R_{th(c-h)}$	Thermal resistance – case to heatsink	Clamping force 37kN (with mounting compound)	Double side	-	0.0025	$^{\circ}\text{C/W}$
			Single side	-	0.005	$^{\circ}\text{C/W}$
T_{vj}	Virtual junction temperature	Blocking V_{DRM} / V_{RRM}	-	125	$^{\circ}\text{C}$	
T_{stg}	Storage temperature range		-55	125	$^{\circ}\text{C}$	
F_m	Clamping force		33	41	kN	

DYNAMIC CHARACTERISTICS

Symbol	Parameter	Test Conditions	Min.	Max.	Units	
I_{RRM}/I_{DRM}	Peak reverse and off-state current	At V_{RRM}/V_{DRM} , $T_{case} = 125^{\circ}C$	-	300	mA	
dV/dt	Max. linear rate of rise of off-state voltage	To 67% V_{DRM} , $T_j = 125^{\circ}C$, gate open	-	1500	V/ μs	
di/dt	Rate of rise of on-state current	From 67% V_{DRM} to $2x I_{T(AV)}$	Repetitive 50Hz	-	150	A/ μs
		Gate source 30V, 10 Ω , $t_r < 0.5\mu s$, $T_j = 125^{\circ}C$	Non-repetitive	-	300	A/ μs
$V_{T(TO)}$	Threshold voltage – Low level	100A to 1500A at $T_{case} = 125^{\circ}C$	-	1.0	V	
	Threshold voltage – High level	1500A to 7200A at $T_{case} = 125^{\circ}C$	-	1.2	V	
r_T	On-state slope resistance – Low level	100A to 1500A at $T_{case} = 125^{\circ}C$	-	0.615	m Ω	
	On-state slope resistance – High level	1500A to 7200A at $T_{case} = 125^{\circ}C$	-	0.5	m Ω	
t_{gd}	Delay time	$V_D = 67\% V_{DRM}$, gate source 30V, 10 Ω $t_r = 0.5\mu s$, $T_j = 25^{\circ}C$	-	3	μs	
t_q	Turn-off time	$T_j = 125^{\circ}C$, $V_R = 200V$, $di/dt = 1A/\mu s$, $dV_{DR}/dt = 20V/\mu s$ linear	-	1200	μs	
Q_S	Stored charge	$I_T = 2000A$, $T_j = 125^{\circ}C$, $di/dt = 1A/\mu s$,	2000	4500	μC	
I_L	Latching current	$T_j = 25^{\circ}C$, $V_D = 5V$	-	3	A	
I_H	Holding current	$T_j = 25^{\circ}C$, $R_{G-K} = \infty$, $I_{TM} = 500A$, $I_T = 5A$	-	300	mA	

GATE TRIGGER CHARACTERISTICS AND RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
V _{GT}	Gate trigger voltage	V _{DRM} = 5V, T _{case} = 25°C	1.5	V
V _{GD}	Gate non-trigger voltage	At 50% V _{DRM} , T _{case} = 125°C	0.4	V
I _{GT}	Gate trigger current	V _{DRM} = 5V, T _{case} = 25°C	350	mA
I _{GD}	Gate non-trigger current	At 50% V _{DRM} , T _{case} = 125°C	15	mA

CURVES

Fig.2 Maximum & minimum on-state characteristics
V_{TM} EQUATION

$$V_{TM} = A + B \ln(I_T) + C \cdot I_T + D \cdot \sqrt{I_T}$$

 Where $A = 0.666848$
 $B = 0.033446$
 $C = 0.000418$
 $D = 0.009666$

 these values are valid for $T_j = 125^\circ\text{C}$ for I_T 100A to 7200A

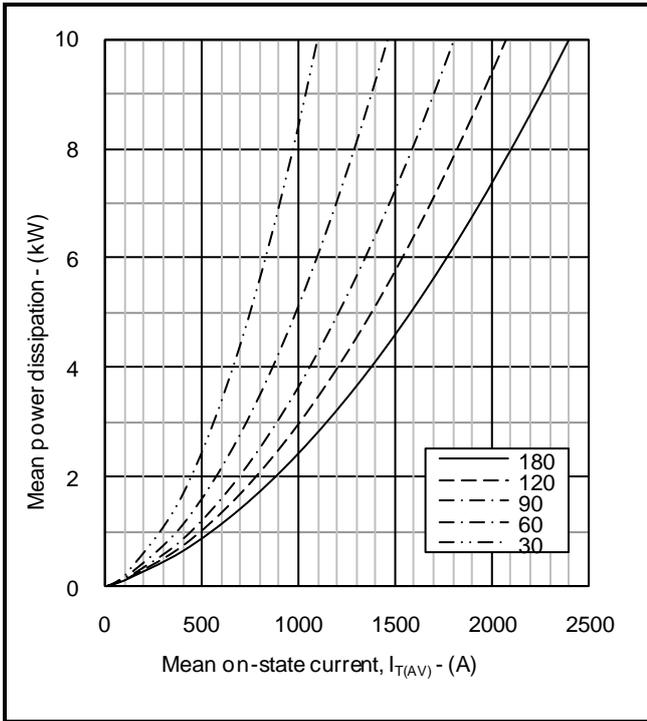


Fig.3 On-state power dissipation – sine wave

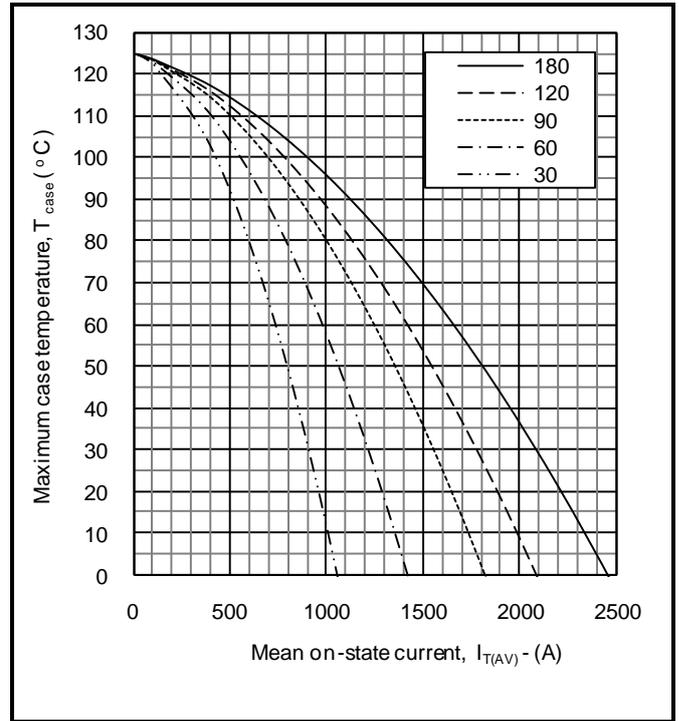


Fig.4 Maximum permissible case temperature, double side cooled – sine wave

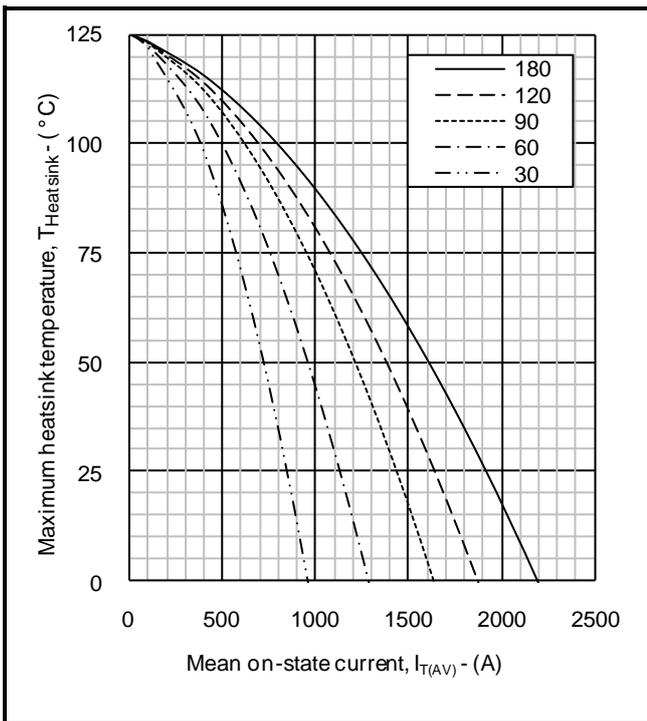


Fig.5 Maximum permissible heatsink temperature, double side cooled – sine wave

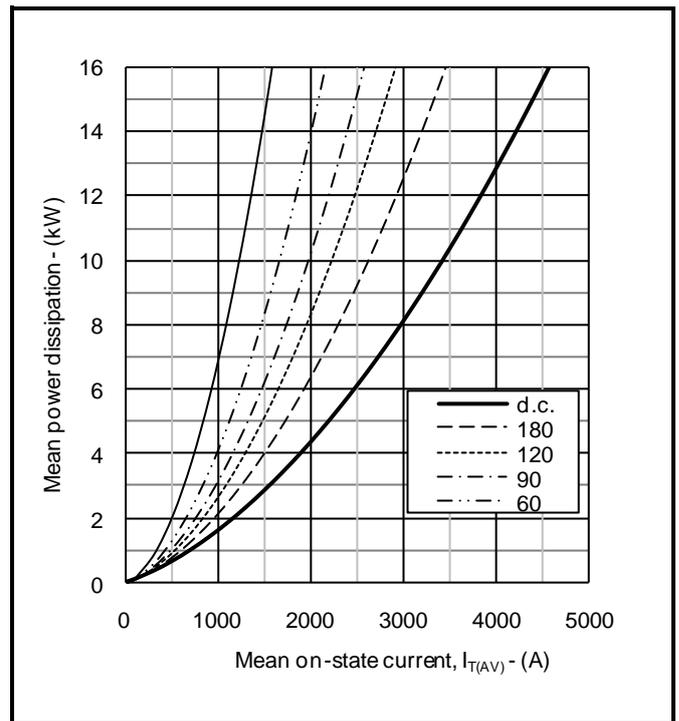


Fig.6 On-state power dissipation – rectangular wave

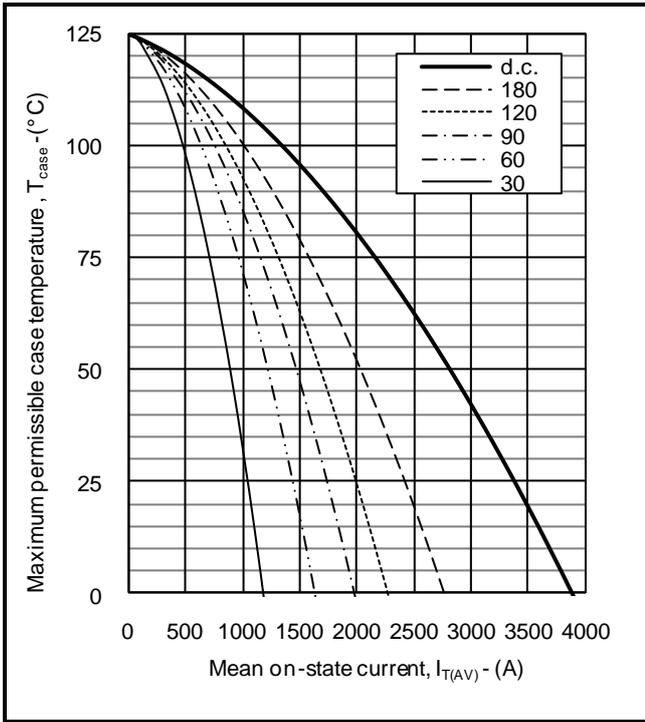


Fig.7 Maximum permissible case temperature, double side cooled – rectangular wave

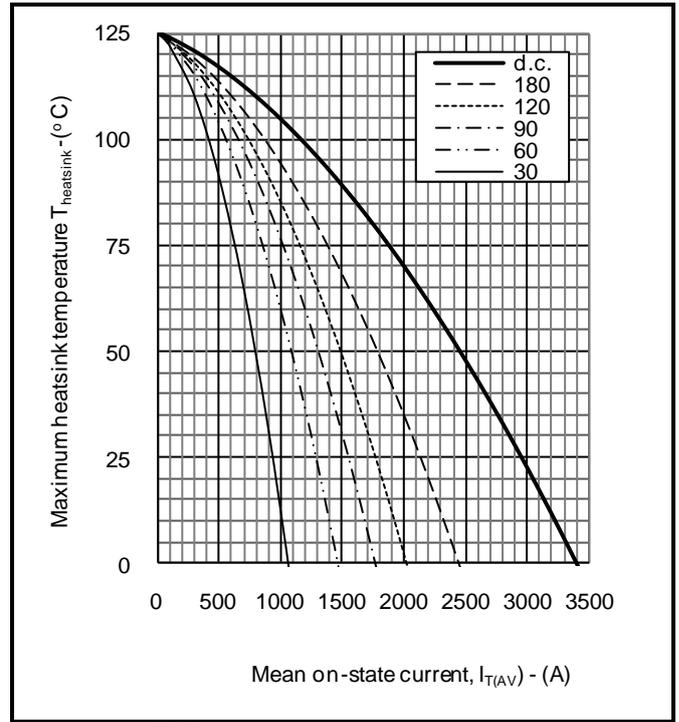


Fig.8 Maximum permissible heatsink temperature, double side cooled – rectangular wave

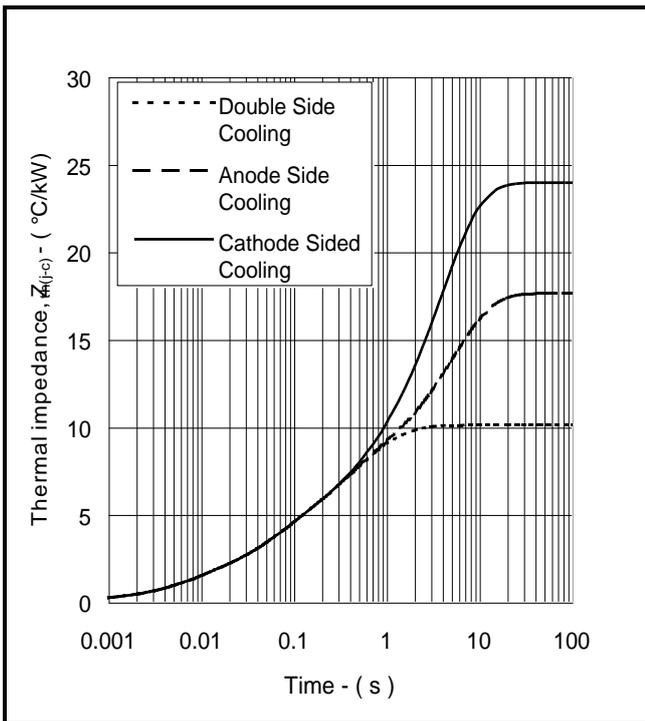


Fig.9 Maximum (limit) transient thermal impedance – junction to case (°C/kW)

Double side cooled	R_i (°C/kW)	1.043	2.576	4.5096	1.9009
	T_i (s)	0.00678	0.057916	0.3820376	1.06
Anode side cooled	R_i (°C/kW)	1.077	2.4396	4.0468	9.9994
	T_i (s)	0.008153	0.050142	0.3129407	5.27
Cathode side cooled	R_i (°C/kW)	1.1613	2.8926	2.4064	17.4793
	T_i (s)	0.008389	0.0582953	0.3765516	3.97

$$Z_{th} = [R_i \times (1 - \exp(-t/t_i))]$$

$\Delta R_{th(j-c)}$ conduction

Tables show the increments of thermal resistance $R_{th(j-c)}$ when the device operates at conduction angles other than d.c.

Double side cooling		
α°	$\Delta Z_{th} (Z)$	
	sine	rect.
180	1.95	1.26
120	2.32	1.89
90	2.74	2.27
60	3.14	2.70
30	3.46	3.19
15	3.61	3.47

Anode Side Cooling		
α°	$\Delta Z_{th} (Z)$	
	sine	rect.
180	1.95	1.26
120	2.32	1.89
90	2.74	2.27
60	3.14	2.70
30	3.46	3.19
15	3.62	3.47

Cathode Sided Cooling		
α°	$\Delta Z_{th} (Z)$	
	sine	rect.
180	1.95	1.26
120	2.31	1.88
90	2.72	2.26
60	3.12	2.68
30	3.43	3.17
15	3.58	3.44

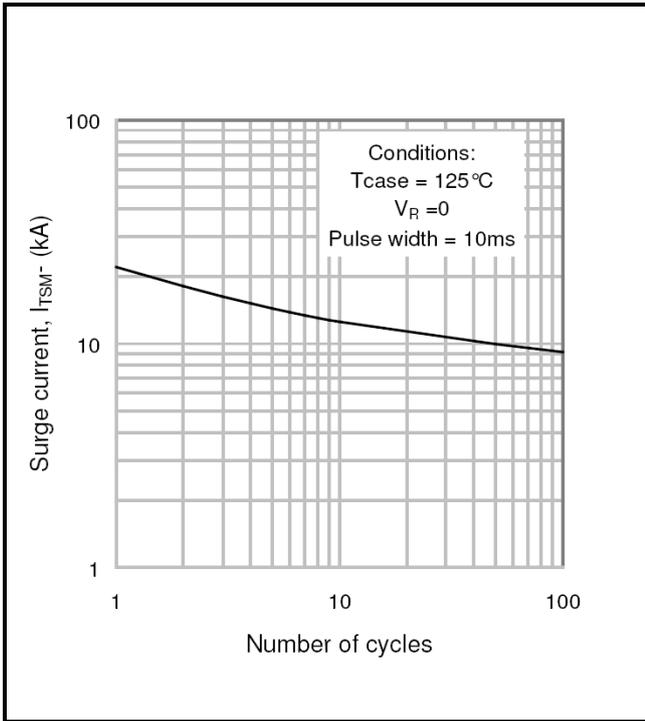


Fig.10 Multi-cycle surge current

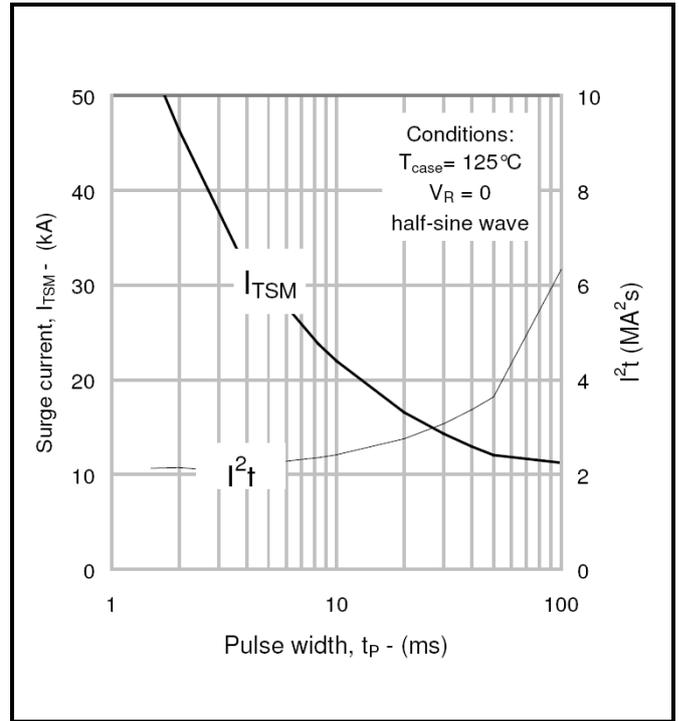


Fig.11 Single-cycle surge current

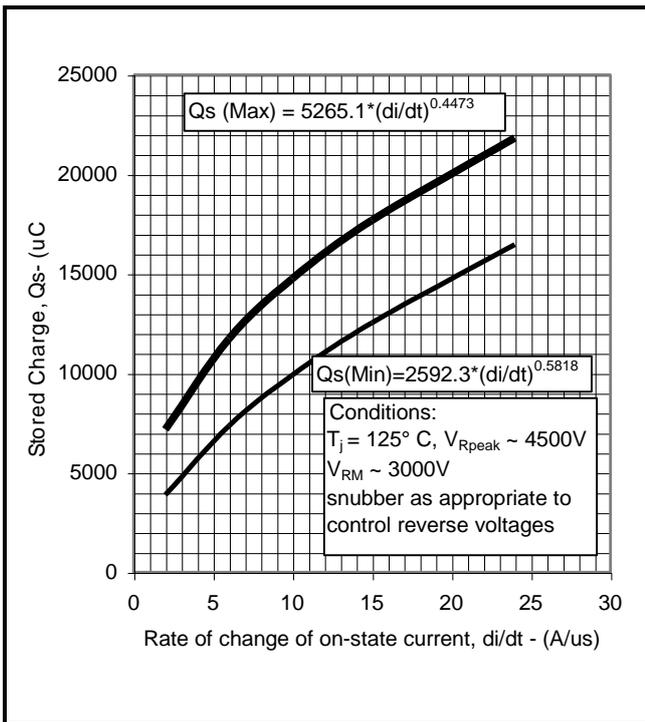


Fig.12 Reverse recovery charge

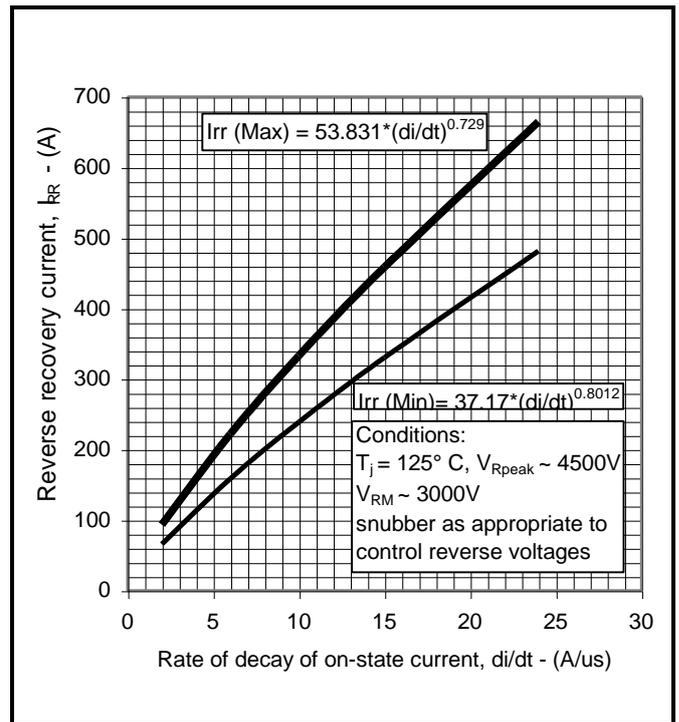


Fig.13 Reverse recovery current

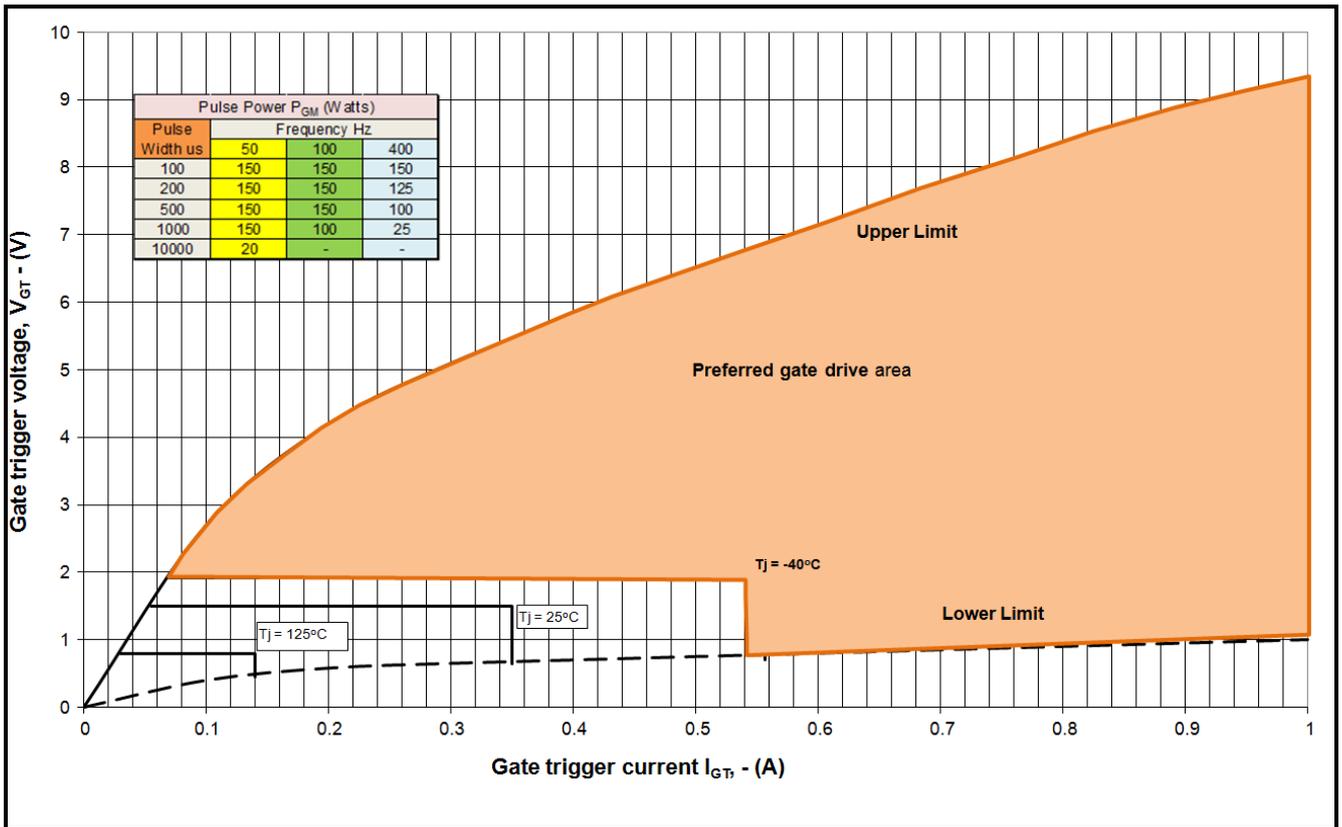


Fig14 Gate Characteristics

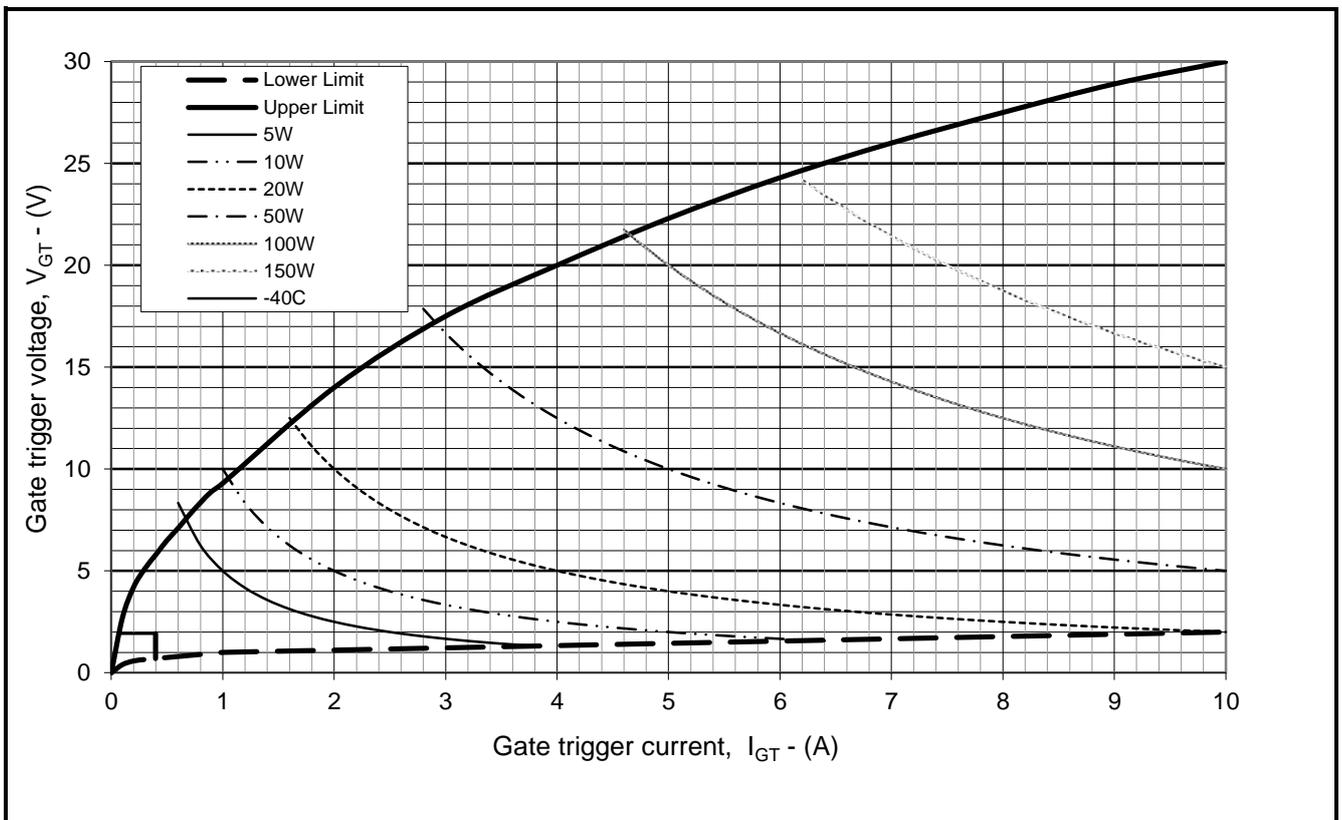


Fig. 15 Gate characteristics

PACKAGE DETAILS

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.

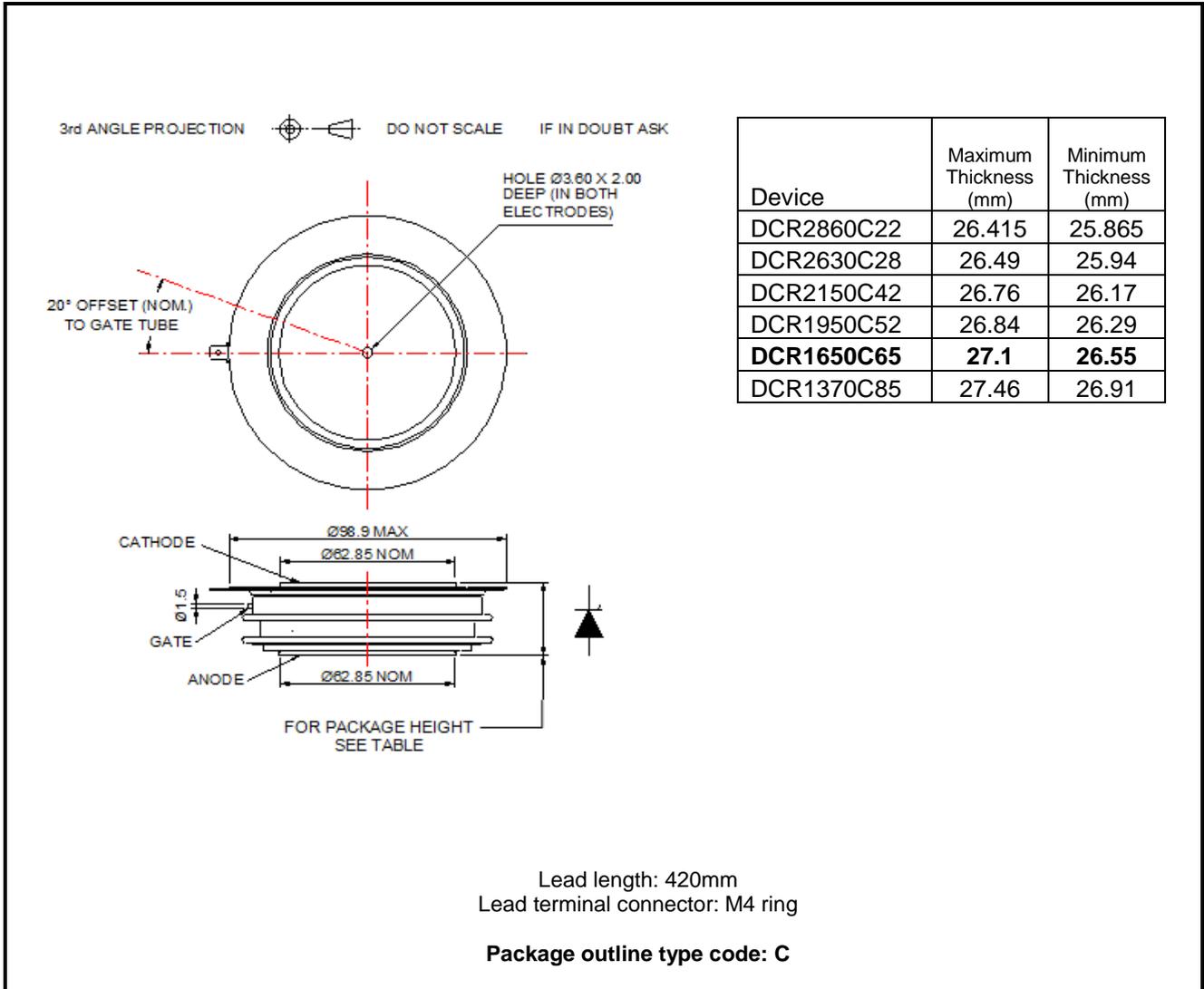


Fig.16 Package outline

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